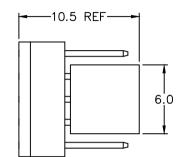
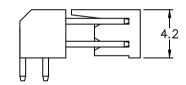


PRODUCT NO POS CONTACT AREA SOLDER AREA

10138622-001LF 2 X 3 0.76um Au DVER Ni 2.54um MATTE Sn



3 |



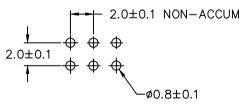
WITH PLASTIC CAP

NOTES:

1. MATERIAL:

BODY: HIGH TEMPERATURE PLASTIC UL 94V-0 BLACK PIN: COPPER ALLOY PLATING: SEE SHEET 2 TABLE

- 2. 10138622-001LF: STANDARD PACKAGING USED BAG. 10138622-001TRLF: PACKAGING USED TAPE AND REEL WITH CAP.
- 3. THE HOUSING WILL WITHSTAND EXPOSURE TO 255°C PEAK TEMPERATURE FOR 10 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
- 4. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.57MM MINIMUM THICK CIRCUIT BOARD.
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.



RECOMMENDED HOLE LAYOUT SCALE 5:1

mat'l. code						surface / tolerance						projection			product family								
						ISO 1302 V ISO 406/ISO 1101									MINITEK HPL577								
ltr	ecn	no	dr	date	e	tolerances unless otherwise s							pecified \			2							
						angl	es 5	-	.0±.3 .00±.13			mm			MINITEK II R/A HEADER								
						0°±2	2 -	.000±.05				scale 1:1			1								
						dr	Laurence Zang		160	315				dwg	no			s	heet	1 (of 1	size	
						engr	Laurence Zang		160315		Amphenel FCi			10138622 A							١,,		
						chr T		im Yao		160315		FCi			10138622 A4								
					арро	Tim Yao		160315		·		type Product Customer Drawing											
sheet index		revision		Α																			
		sheet		2																			

form: A4mmXLc-2016-02-24

В

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Mouser Electronics

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